

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

| SUBMISSION TYPE: | NEW ASSIGNMENT | | | | | | | | |
|--|--|---------------|--|----------------------------|----------------------------------|--------------|---------------------------|-----------------------|-------------------|
| NATURE OF CONVEYANCE: | ASSIGNMENT | | | | | | | | |
| CONVEYING PARTY DATA | | | | | | | | | |
| <table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>Jung Hwan Chun</td> <td>08/10/2009</td> </tr> <tr> <td>Gyu Han Kim</td> <td>08/10/2009</td> </tr> </tbody> </table> | | Name | Execution Date | Jung Hwan Chun | 08/10/2009 | Gyu Han Kim | 08/10/2009 | | |
| Name | Execution Date | | | | | | | | |
| Jung Hwan Chun | 08/10/2009 | | | | | | | | |
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| RECEIVING PARTY DATA | | | | | | | | | |
| <table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;">Name:</td> <td>STS Semiconductor & Telecommunications Co., Ltd.</td> </tr> <tr> <td>Street Address:</td> <td>555-9 Baekseok-dong, Cheonan-si.</td> </tr> <tr> <td>City:</td> <td>331-220 Chungcheongnam-Do</td> </tr> <tr> <td>State/Country:</td> <td>REPUBLIC OF KOREA</td> </tr> </table> | | Name: | STS Semiconductor & Telecommunications Co., Ltd. | Street Address: | 555-9 Baekseok-dong, Cheonan-si. | City: | 331-220 Chungcheongnam-Do | State/Country: | REPUBLIC OF KOREA |
| Name: | STS Semiconductor & Telecommunications Co., Ltd. | | | | | | | | |
| Street Address: | 555-9 Baekseok-dong, Cheonan-si. | | | | | | | | |
| City: | 331-220 Chungcheongnam-Do | | | | | | | | |
| State/Country: | REPUBLIC OF KOREA | | | | | | | | |
| PROPERTY NUMBERS Total: 1 | | | | | | | | | |
| <table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 30%;">Property Type</th> <th style="width: 70%;">Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12549825</td> </tr> </tbody> </table> | | Property Type | Number | Application Number: | 12549825 | | | | |
| Property Type | Number | | | | | | | | |
| Application Number: | 12549825 | | | | | | | | |
| CORRESPONDENCE DATA | | | | | | | | | |
| <p>Fax Number: (203)327-1096</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 203-324-6155</p> <p>Email: ccobb@ssjr.com</p> <p>Correspondent Name: Stephen P. McNamara</p> <p>Address Line 1: 986 Bedford Street</p> <p>Address Line 2: St. Onge Steward Johnston & Reens LLC</p> <p>Address Line 4: Stamford, CONNECTICUT 06905</p> | | | | | | | | | |
| ATTORNEY DOCKET NUMBER: | 05274-P0002A | | | | | | | | |
| NAME OF SUBMITTER: | Stephen P. McNamara | | | | | | | | |
| <p>Total Attachments: 3</p> <p>source=Assignment to STS Semiconductor & Telecommunications Co. Ltd#page1.tif</p> <p>source=Assignment to STS Semiconductor & Telecommunications Co. Ltd (2)#page1.tif</p> <p>source=Assignment to STS Semiconductor & Telecommunications Co. Ltd (3)#page1.tif</p> | | | | | | | | | |

OP \$40.00 12549825

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PATENT
REEL: 023182 FRAME: 0628

Assignment

WHEREAS, We, the undersigned inventors, have made certain inventions or discoveries (or both) as set forth in an application for Letters Patent of the United States of America, entitled

METHOD OF DICING WAFER USING PLASMA

bearing Patent Application Serial No. 12/549,825, filed on August 28, 2009;

WHEREAS, STS SEMICONDUCTOR & TELECOMMUNICATIONS CO., LTD.,

A corporation organized and existing under the laws of Rep. of Korea, and having an office and place of business at 555-9 Baekseok-dong, Cheonan-si, Chungcheongnam-Do 331-220 Rep.of Korea,

and, together with its successors and assigns is hereinafter called "Assignee", and is desirous of acquiring the title, rights, benefits and privileges hereinafter recited;

NOW THEREFORE, for valuable consideration furnished by Assignee to us, receipt and sufficiency of which we hereby acknowledge, we hereby, without reservation:

1. Assign, transfer and convey to Assignee the entire right, title and interest in and to said inventions and discoveries, said application for Letters Patent of the United States of America, any and all other applications for Letters Patent on said inventions and discoveries in whatsoever countries, including all divisional, renewal, substitute, continuation and convention applications based in whole or in part upon said inventions or discoveries, or upon said applications, and any and all Letters Patent, reissues and extensions of Letters Patent granted for said inventions and discoveries or upon said applications, and every priority right that is or may be predicated upon or arise from said inventions, said discoveries, said applications and said Letters Patent;
2. Authorize Assignee to file patent applications in any or all countries on any or all of said inventions and discoveries in our names or in the name of Assignee or otherwise as Assignee may deem advisable, under the International Convention or otherwise;
3. Authorize and request the Commissioner of Patents of the United States of America and the empowered officials of all other governments to issue or transfer all said Letters Patents to Assignee, as assignee of the entire right, title and interest therein or otherwise as Assignee may direct;
4. Warrant that we have not knowingly conveyed to others any right in said inventions, discoveries, applications or patents or any license to use the same or to make, use or sell anything embodying or utilizing any of said inventions or discoveries; and that we have good right to assign the same to Assignee without encumbrance;

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Assignment

Applicant: STS SEMICONDUCTOR & TELECOMMUNICATIONS CO., LTD.

5. Bind our heirs, legal representatives and assigns, as well as ourselves, to do, upon Assignee's request and at Assignee's expense, but without additional consideration to us or them, all acts reasonably serving to assure that said inventions and discoveries, said patent applications and said Letters Patent shall be held and enjoyed by Assignee as fully and entirely as the same could have been held and enjoyed by us, our heirs, legal representatives and assigns if this assignment had not been made; and particularly to execute and deliver to Assignee all lawful application documents, including petitions, specifications, and oaths, and all assignments, disclaimers, and lawful affidavits in form and substance as may be requested by Assignee; to communicate to Assignee all facts known to us relating to said inventions and discoveries or the history thereof; and to furnish Assignee with any and all documents, photographs, models, samples and other physical exhibits in our control or in the control of our heirs, legal representatives or assigns, which may be useful for establishing the facts of our conceptions, disclosures, and reduction to practice of said inventions and discoveries.

IN WITNESS WHEREOF, we, CHUN, Jung Hwan and KIM, Gyu Han, have hereunto set our hands and affixed our seals.

Date

2009. 08. 10CHUN, Jung Hwan

103-107 Seonggeo Byeoksan Apt.,
Sinwol-ri, Seonggeo-eup, Seobuk-gu,
Cheonan-si, Chungcheongnam-do
331-856 Rep. of Korea

Declaration of Witness

I declare that I was personally present and did see CHUN, Jung Hwan, who is personally known to me to be the person named in this assignment, duly sign and execute the same.

Declared at Seoul, Rep. of Korea, on 2009. 8. 10

Signature of Witness

LEE, Hye Min

Full Name of Witness

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Assignment

Applicant: STS SEMICONDUCTOR & TELECOMMUNICATIONS CO., LTD.

2009. 08. 10
Date



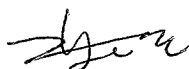
KIM, Gyu Han

101-108 Aju 1Cha Apt., Jisan-dong,
Pyeongtaek-si, Gyeonggi-do
459-752 Rep. of Korea

Declaration of Witness

I declare that I was personally present and did see **KIM, Gyu Han**, who is personally known to me to be the person named in this assignment, duly sign and execute the same.

Declared at Seoul, Rep. of Korea, on 2009. 8. 10.



Signature of Witness
LEE, Hye Min

Full Name of Witness